

EECS151/251A Spring 2023 Digital Design and Integrated Circuits

Instructor: John Wawrzynek Lecture 26: Wrap-up

Announcements

- □ Homework assignment 10 posted due next Monday.
- □ HW 11 final problem set posted end of this week.
- Final project checkoffs will be Thursday of next week (RRR).
- Final reports will be due Monday at midnight of exam week.
- Apple has generously offered to offer prizes for the best projects this semester:
 - The top ASIC project (2 students), & the top 3 FPGA projects (6 students)
 - The student can choose either an Apple Watch (SE GPS, 40mm) or Airpod Pro.





Important takeawaysExam Topics

Why Study and Learn Digital Design?

- We expect that many of you will eventually be employed as designers.
 - Digital design is not a spectator sport. The only way to learn it, and to appreciate the issues, is to do it.
 - To a large extent, it comes with practice/experience (this course is just the beginning).
 - Another way to get better is to study other designs. Not time to do much of this during the semester, but a good practice for later.
- However, a significant percentage of our graduates will not be digital designers. What's in it for them?
 - Better manager of designers, marketers, field engineers, etc.
 - Better researcher/scientist/designer in related areas
 - Software engineers, fabrication process development, etc.
 - Even to become a better user of electronic systems.

In What Context Will You be Designing?

Engineers learn so that they can build. Scientists build so that they can learn.

□ Electronic design is a critical tool for most areas of pure science:

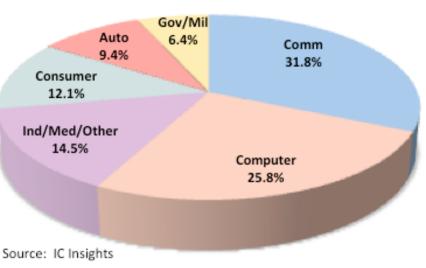
- Astrophysics special electronics used for processing radio antenna signals.
- Genomics special processing architectures for DNA string matching.
- In general sensor processing, control, and number crunching.
- Machine Learning now relies heavily on special hardware.
- In some fields, computation has replaced experimentation particle physics, world weather prediction (fluid dynamics).
- In computer engineering, prototypes often designed, implemented, and studied to "prove out" an idea. Common within universities and industrial research labs. Lessons learned and proven ideas often transferred to industry through licensing, technical communications, or startup companies.
 - RISC processors were first proved out at Berkeley and IBM Research

Designs in Industry

Of course, companies are the primary employer of designers. Provide some useful products to society or government and make a profit for the shareholders.

Interesting recent shift

- All software giants now have hardware design teams (embedded and chips)
- Google, Amazon, Facebook, Microsoft, …



Global Electronic System Production (\$1.62T, 2018F)

Ten Big Ideas from EECS151

- Modularity and Hierarchy is an important way to describe and think about digital systems.
- 2. <u>Parallelism</u> is a key property of hardware systems and distinguishes them from serial software execution.
- 3. <u>Clocking and the use of state</u> <u>elements (latches, flip-flops, and</u> memories) control the flow of data.
- 4. <u>Cost/Performance/Power</u> <u>tradeoffs</u> are possible at all levels of the system design.
- 5. <u>Boolean Algebra</u> and other logic representations.

- Hardware Description Languages
 (HDLs) and Logic Synthesis are a central tool for digital design.
- 7. <u>Datapath + Controller</u> is a effective design pattern.
- 8. <u>Finite State Machines</u> abstraction gives us a way to model any digital system – used for designing controllers.
- 9. <u>Arithmetic circuits</u> are often based on "long-hand" arithmetic techniques.
- **10.<u>FPGAs + ASICs</u>** give us a convenient and flexible implementation technology.

What We Didn't Cover

Design Verification and Testing

- Industrial designers spend more than half their time testing and verifying correctness of their designs.
 - Some of this covered in the lab and a bit in lecture. Didn't cover rigorous testing procedures.
- Most industrial products are designed from the start for testability. Important for design verification and later for manufacturing test.
- Related: Fault modeling and fault tolerant design.
- Other High-level Optimization Techniques
 - High-level Synthesis now starting to catch on
- Other High-level Architectures: GPUs, video processing, network routers, …
- Asynchronous Design

Most Closely Related Courses

□ CS152 Computer Architecture and Engineering

- Design and Analysis of Microprocessors
- Applies basic design concepts from EECS151
- EE251B Advanced Digital Integrated Circuits and Systems
 - Transistor-level design of ICs
 - More on Advanced ASIC Tool use
- □ EE 194/290C: The Tapeout Class

Future Design Issues

- Automatic High-level synthesis (HLS) and optimization (with micro-architecture synthesis) and hardware/software co-design.
- Machine Learning and Digital Design:
 - Can ML techniques help us design better systems or do it more quickly?
- Current practice is "system on a chip" (SOC) design methodology:
 - Pre-designed subsystems (processor cores, bus controllers, memory systems, network interfaces, etc.) connected with standard on-chip interconnect or bus.
 - Strong emphasis on "accelerators" for energy efficiency and performance.

A number of alternatives to silicon VLSI have been proposed, including techniques based on:

- Carbon nanotubes*, molecular electronics, quantum mechanics, and biological processes.
- How will these change the way we design systems?

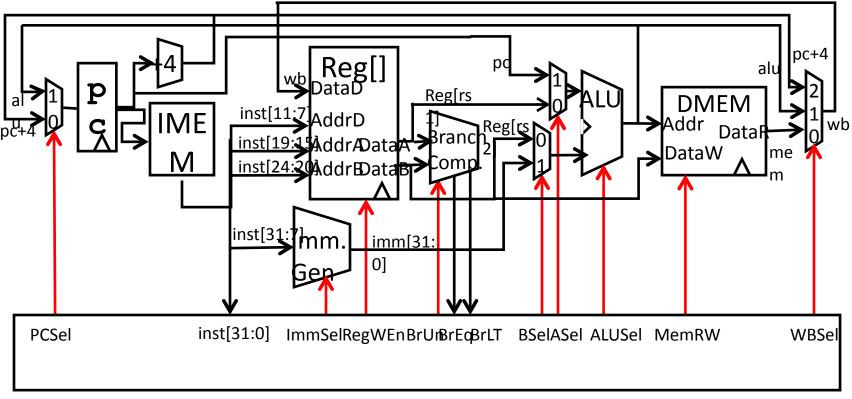
*In 2012, IBM produced a sub-10 nm carbon nanotube transistor that outperformed silicon on speed and power. "The superior low-voltage performance of the sub-10 nm CNT transistor proves the viability of nanotubes for consideration in future aggressively scaled transistor technologies", according to the abstract of the paper in Nano Letters.

Final Exam and Project Info

- Exam held Wed, May 10 11:30A 2:30P Physics Building 4
 - "Comprehensive" Final Exam
 - Emphasis on second half, but some coverage of first half
 - Same format as Exam 1. Closed-book and notes, one page of notes.
- Project interviews: Thursday of RRR week, 5/4. Signup!
- Project final reports due Monday 5/8, midnight.

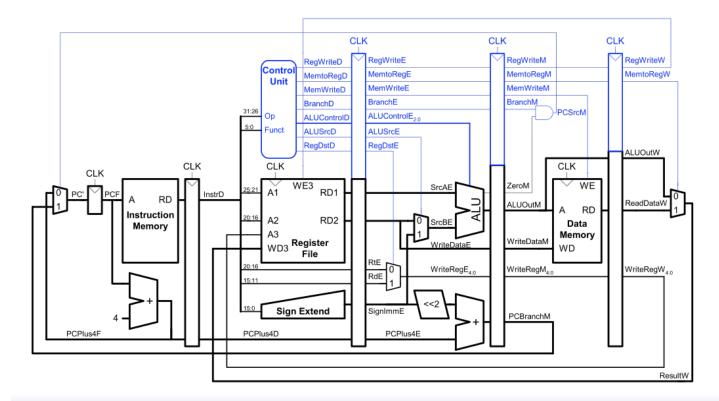
How to Design a RISC-V Single-Cycle Processor from the ISA

Single-Cycle RISC-V RV32I Datapath

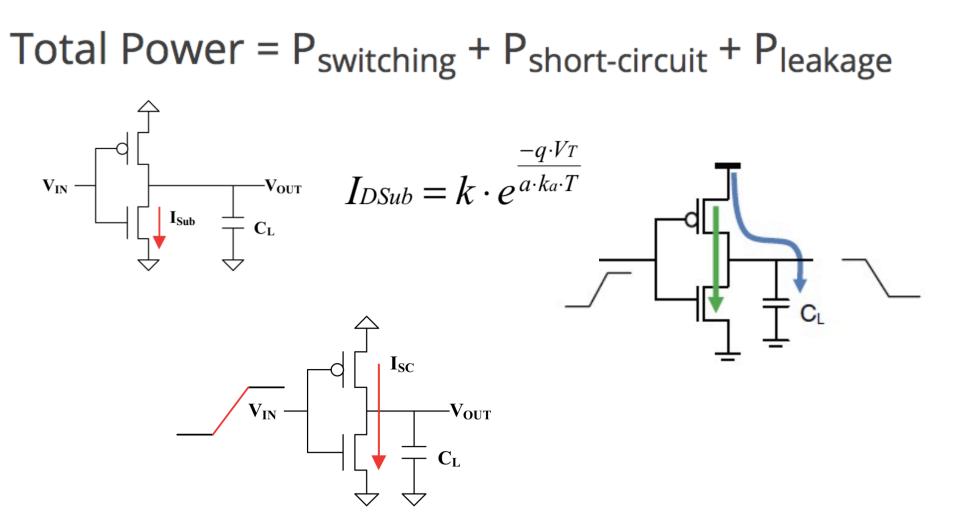


Processor Pipelining Hazards and Mechanisms

Pipelined Processor



Sources of Power and Energy consumption in Digital ICs



Some low-power design techniques

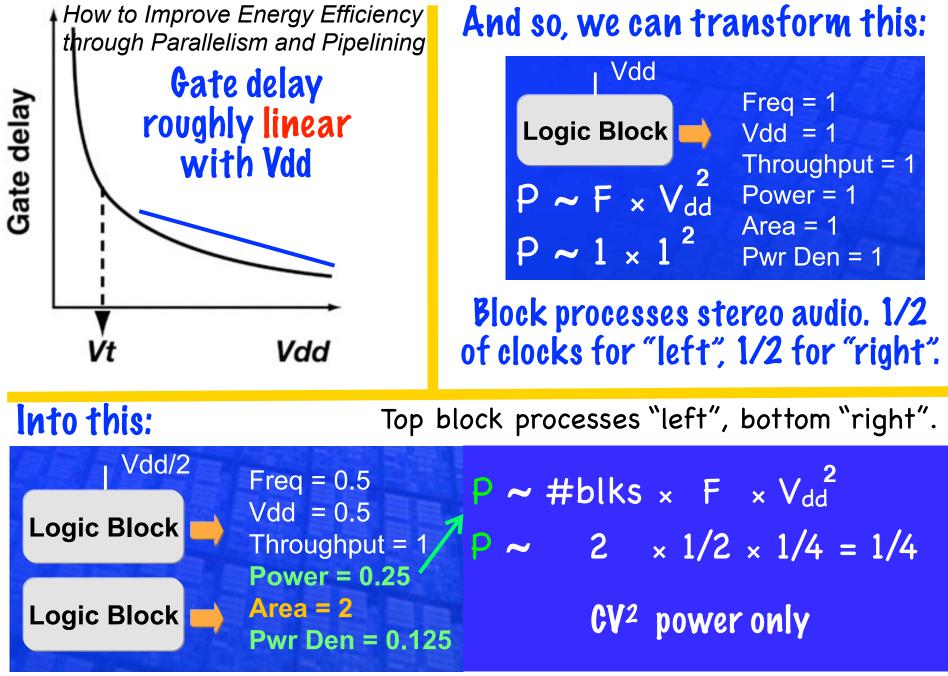
H Parallelism and pipelining



Slow down non-critical paths

H Thermal management

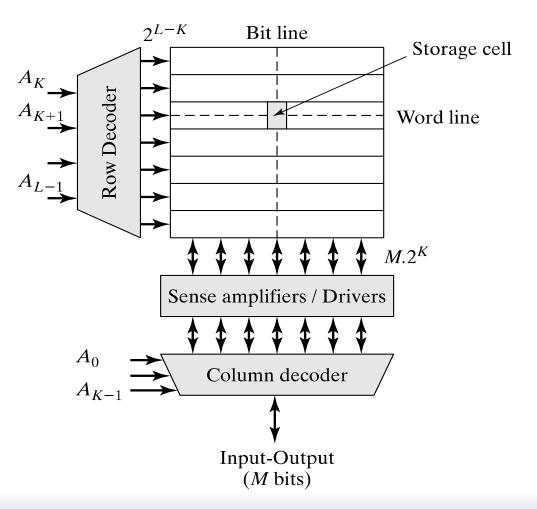
Principles Behind 4 Low-power Design Techniques



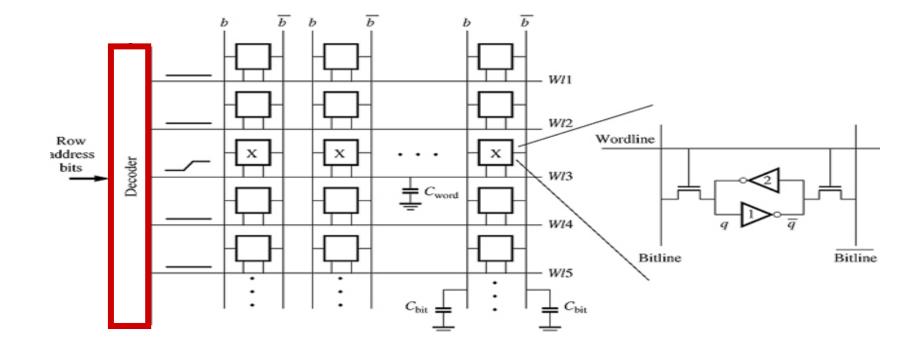
THIS MAGIC TRICK BROUGHT TO YOU BY CORY HALL ...

Memory Block Internal Architecture Memory Architecture Overview

- Word lines used to select a row for reading or writing
- Bit lines carry data to/from periphery
- Core aspect ratio keep close to 1 to help balance delay on word line versus bit line
- Address bits are divided between the two decoders
- Row decoder used to select word line
- Column decoder used to select one or more columns for input/output of data



SRAM Cell and Read/Write Operation SRAM read/write operations



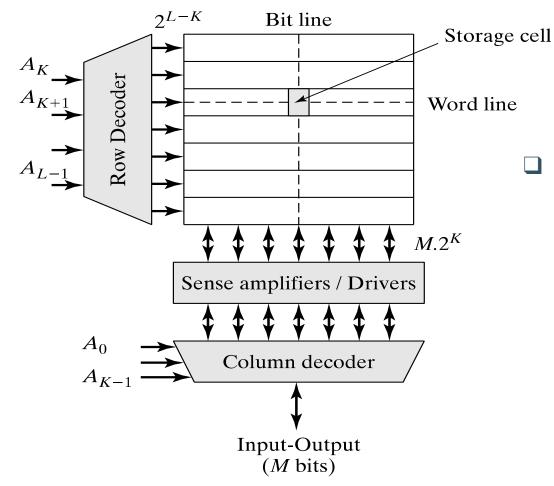
Memory Block Periphery Circuits



Decoders Sense Amplifiers Input/Output Buffers Control / Timing Circuitry

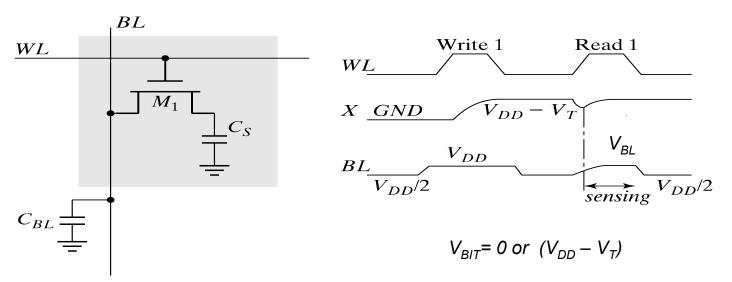
Memory Decoder Design **Row Decoder**

 Expands L-K address lines into 2^{L-K} word lines



- Example: decoder for 8Kx8 memory block
 - core arranged as
 256x256 cells
 - Need 256 AND gates, each driving one word line

DRAM Cell and Read/Write Operation 1-Transistor DRAM Cell



Write: C _S is charged or discharged by asserting WL and BL. Read: Charge redistribution takes places between bit line and storage capacitance

 $C_{S} \ll C_{BL}$ Voltage swing is small; typically around 250 mV.

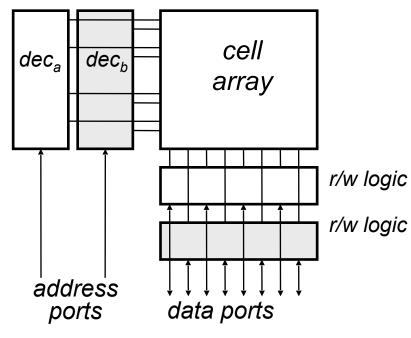
□ To get sufficient C_s, special IC process is used

- Cell reading is destructive, therefore read operation always is followed by a write-back
- Cell looses charge (leaks away in ms highly temperature dependent), therefore cells occasionally need to be "refreshed" - read/write cycle

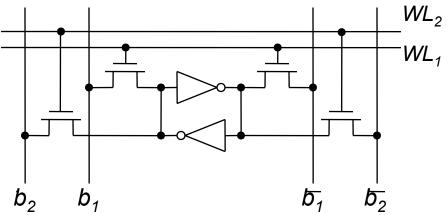
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Dual-port Memory Architecture Dual-ported Memory Internals

Add decoder, another set of read/write logic, bits lines, word lines:



• Example cell: SRAM

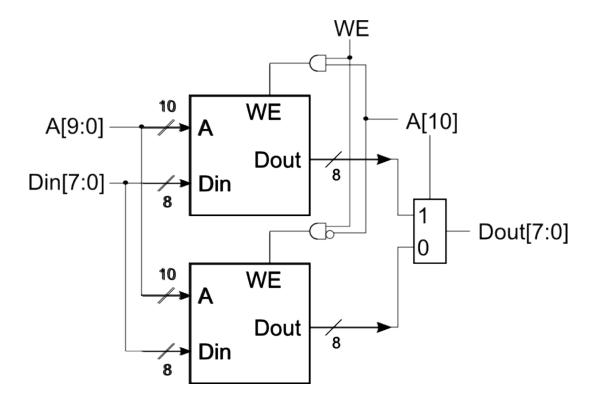


- Repeat everything but cross-coupled inverters.
- This scheme extends up to a couple more ports, then need to add additional transistors.

Cascading Memory blocks for More Width, Depth, and Ports Cascading Memory-Blocks

How to make larger memory blocks out of smaller ones.

Increasing the depth. Example: given 1Kx8, want 2Kx8



FIFO Implementation **FIFO Implementation Details**

- Assume, <u>dual-port memory</u> with asynchronous read, synchronous write.
- <u>Binary counter</u> for each of read and write address. CEs (count enable) controlled by WE and RE.
- Equal comparator to see when pointers match.
- <u>State elements</u> for FULL and EMPTY flags:

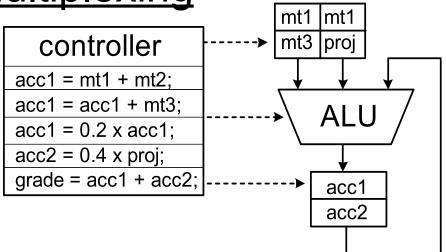
WE RE equal* EMPTY _i FULL _i						
0	0	0	0	0		
0	0	1	EMPTY _{i-1}	FULL _{i-1}		
0	1	0	0	0		
0	1	1	1	0		
1	0	0	0	0		
1	0	1	0	1		
1	1	0	0	0		
1	1	1	EMPTY _{i-1}	FULL _{i-1}		
				I		

• <u>Control logic (FSM)</u> with truth-table (draft) shown to left.

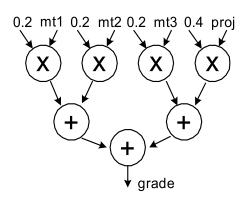
* Actually need 2 signals: "will be equal after read" and "will be equal after write"

Serialization versus Parallelization in Iterative Computations <u>Time-Multiplexing</u>

- *Time multiplex* single ALU for all adds and multiplies:
- Attempts to minimize cost at the expense of time.
 - Need to add extra register, muxes, control.



• If we adopt above approach, we can then consider the combinational hardware circuit diagram as an *abstract computation-graph*.

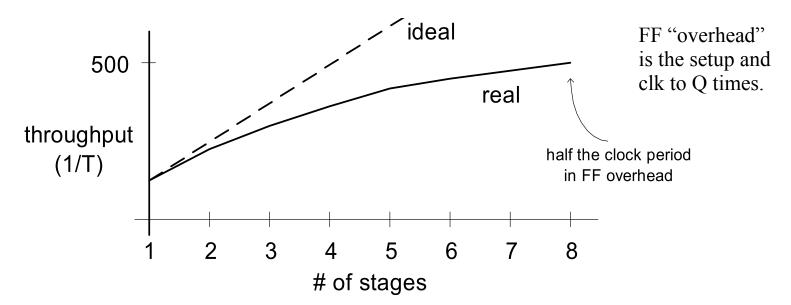


Using other primitives, other coverings are possible. $A \xrightarrow{B} \\ X \xrightarrow{C} \\ +$

• This time-multiplexing "covers" the computation graph by performing the action of each node one at a time. (Sort of *emulates* it.) Fall 2019 EECS151/251A Page 25

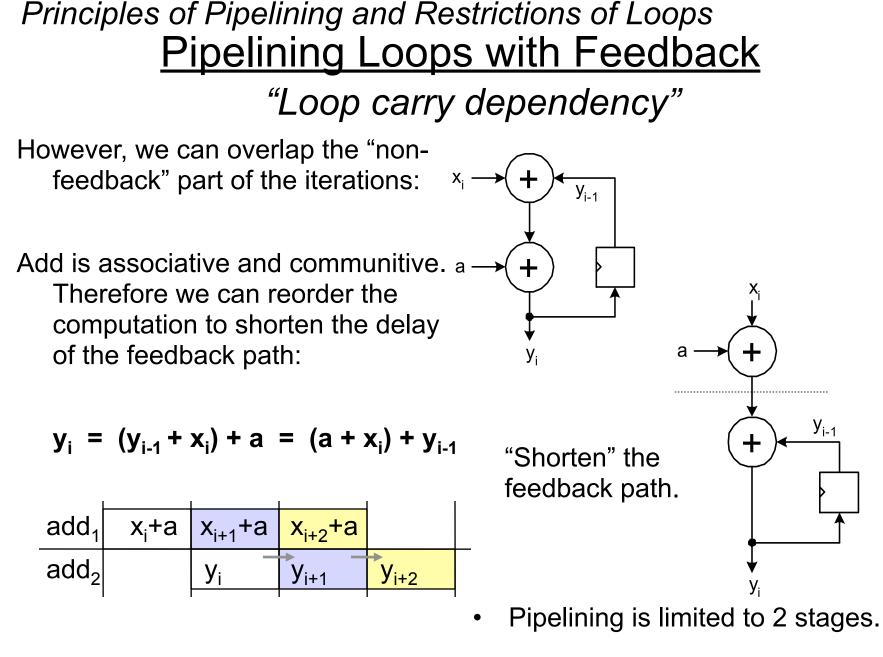
Principles of Pipelining and Restrictions of Loops Limits on Pipelining

- Without FF overhead, throughput improvement α # of stages.
- After many stages are added FF overhead begins to dominate:



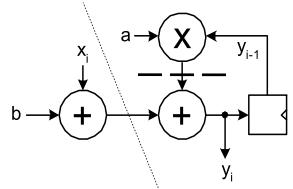
- Other limiters to effective pipelining:
 - clock skew contributes to clock overhead
 - unequal stages
 - FFs dominate cost
 - clock distribution power consumption
 - feedback (dependencies between loop iterations)

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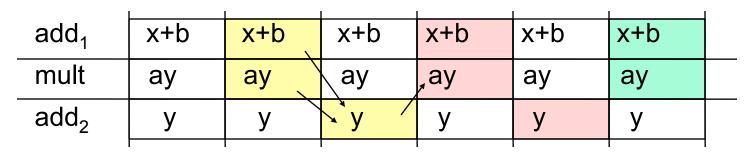
C-Slow Technique for Pipelining Loops <u>"C-slow" Technique</u>

• Essentially this means we go ahead and cut feedback path:



 This makes operations in adjacent pipeline stages independent and allows full cycle for each:

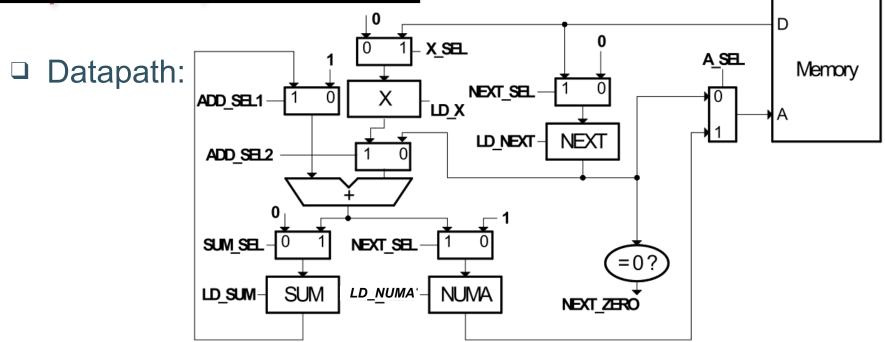
- C computations (in this case C=2) can use the pipeline simultaneously.
- Must be independent.
- Input MUX interleaves input streams.
- Each stream runs at half the pipeline frequency.
- Pipeline achieves full throughput.



Multithreaded Processors use this.

List Processor Design and Optimizations

5. Optimization, Architecture #4



Incremental cost:

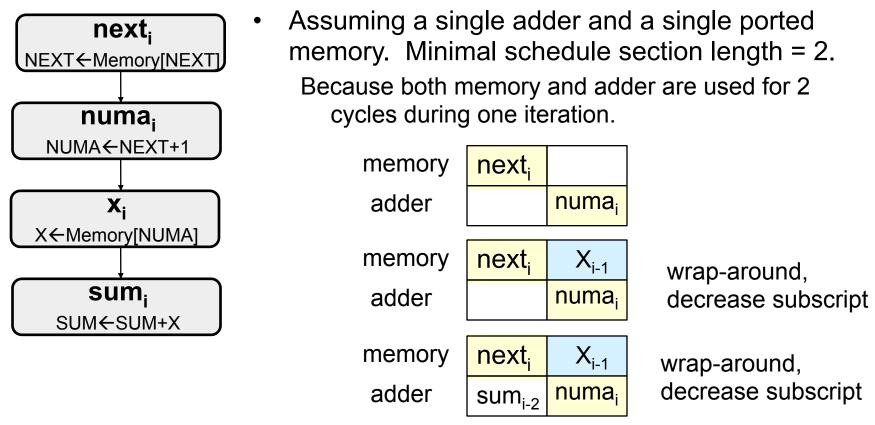
- Addition of another register & mux, adder mux, and control.

Performance: find max time of the four actions

- 1. X←Memory[NUMA], NUMA←NEXT+1;
- 2. NEXT←Memory[NEXT], SUM←SUM+X;

$$0.5+1+10+1+0.5 = 13ns$$
same for all \Rightarrow T>13ns, F<77MHz

Modulo Scheduling Modulo Scheduling List Processor

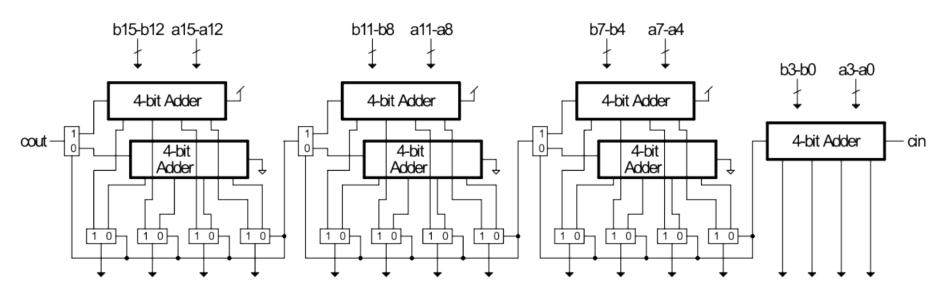


• Finished schedule for 4 iterations:

Memory	next ₁		next ₂	X ₁	next ₃	X ₂	next ₄	X ₃	
adder		numa ₁		numa ₂	sum ₁	numa ₃	sum ₂	numa ₄	sum ₃
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Carry Select Adder Design Carry Select Adder

Extending Carry-select to multiple blocks

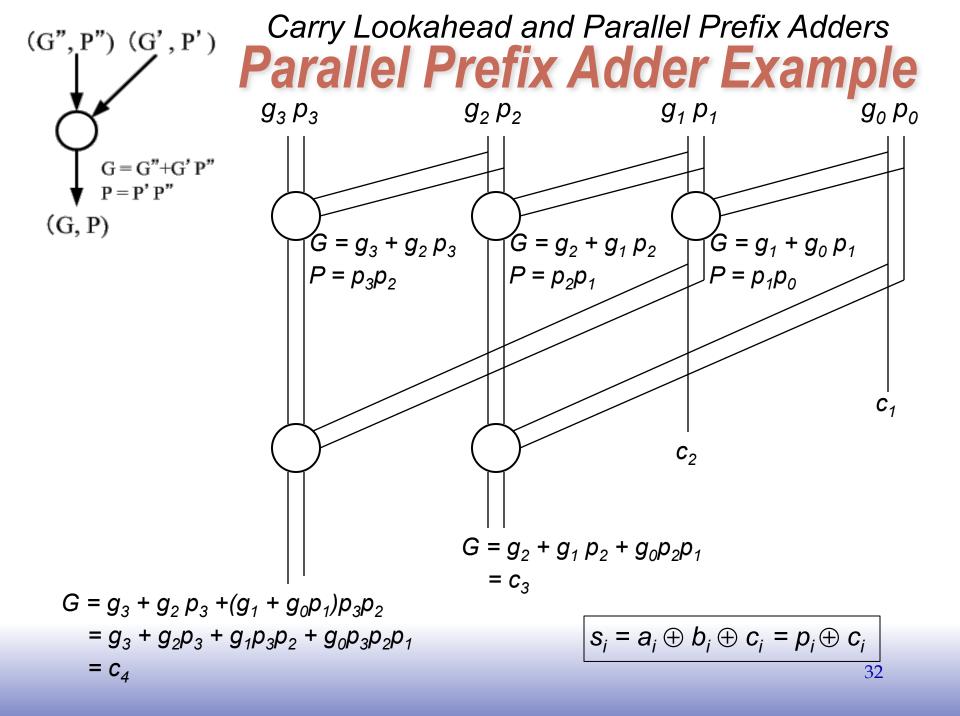


□ What is the optimal # of blocks and # of bits/block?

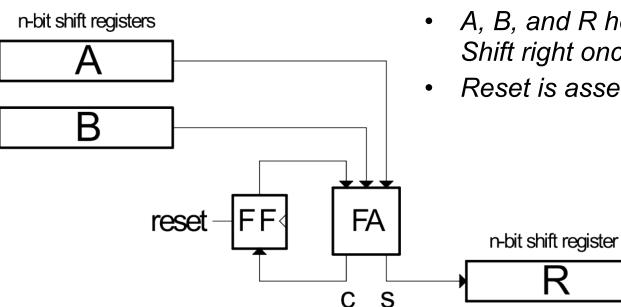
- If blocks too small delay dominated by total mux delay
- If blocks too large delay dominated by adder ripple delay



T α sqrt(N), Cost ≈2*ripple + muxes



Bit-serial Adder

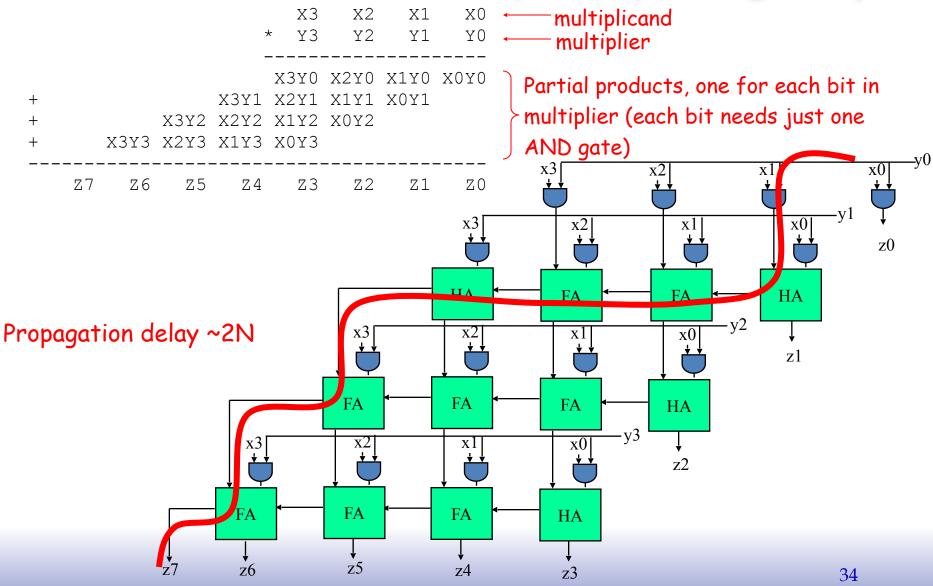


Bit-Serial Addition

- A, B, and R held in shift-registers. Shift right once per clock cycle.
- Reset is asserted by controller.

- □ Addition of 2 n-bit numbers:
 - takes n clock cycles,
 - uses 1 FF, 1 FA cell, plus registers
 - the bit streams may come from or go to other circuits, therefore the registers might not be needed.

Array Multiplier Design Combinational Multiplier (unsigned)



Carry Save Addition Carry-Save Addition

- Speeding up multiplication is a matter of speeding up the summing of the partial products.
- "Carry-save" addition can help.
- Carry-save addition passes (saves) the carries to the output, rather than propagating them.

• Example: sum three numbers, $3_{10} = 0011$, $2_{10} = 0010$, $3_{10} = 0011$

ion can help.
n passes
to the output,
pating them.
carry-save add
carry-propagate add

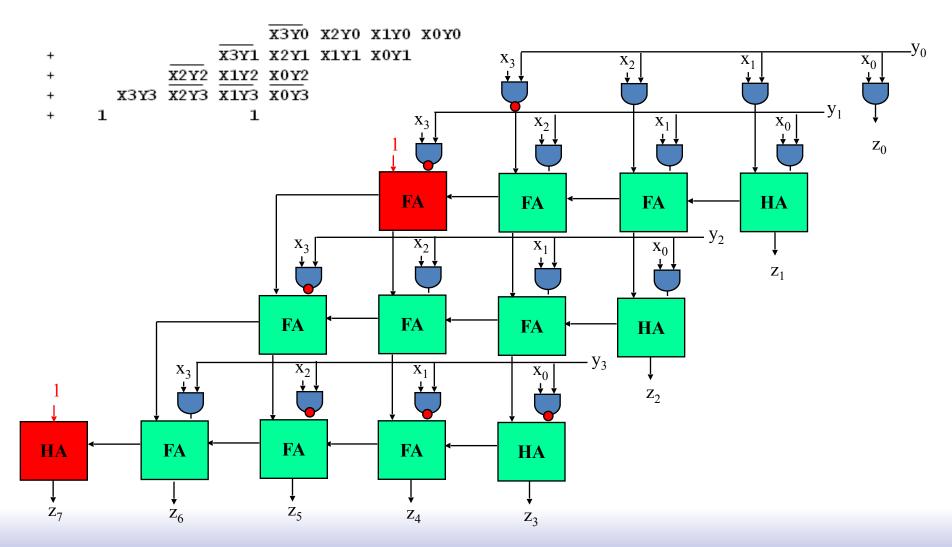
$$\begin{cases}
3_{10} & 0010 \\
0 & 000 = 4_{10} \\
0 & 0001 = 1_{10}
\end{cases}$$
carry-save add

$$\begin{cases}
3_{10} & 0011 \\
0 & 0011 \\
0 & 0010 = 2_{10} \\
0 & 0100 = 8_{10}
\end{cases}$$
carry-save add

- In general, *carry-save* addition takes in 3 numbers and produces 2.
 - Sometimes called a "3:2 compressor": 3 input signals into 2 in a potentially lossy operation
- Whereas, carry-propagate takes 2 and produces 1.
- With this technique, we can avoid carry propagation until final addition

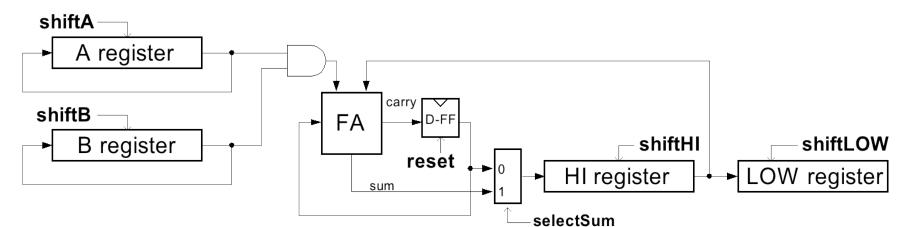
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Signed Multiplication **2's Complement Multiplication**



Bit-Serial Multiplication Bit-serial Multiplier

• Bit-serial multiplier (n² cycles, one bit of result per n cycles):



• Control Algorithm:

```
repeat n cycles { // outer (i) loop
repeat n cycles { // inner (j) loop
shiftA, selectSum, shiftHI
}
Note: The occurrence of a control
signal x means x=1. The absence
of x means x=0.
```

Booth recoding

Booth Encoding Multiplication

(On-the-fly canonical signed digit encoding!)

current bit pair

from previous bit pair

• •		•			
$B_{K^{+1}}$	B_{K}	B_{K-1}	action		P + A = O + A > O
0	0	0	add O		$B_{K+1,K}^{*}A = 0^{*}A \rightarrow 0$ $= 1^{*}A \rightarrow A$
0	0	1	add A		$= 2^*A \rightarrow 4A - 2A$
0	1	0	add A		= 3*A → 4A - A
0	1	1	add 2*A		
1	0	0	sub 2*A		
1	0	1	sub A	←	-2*A+A
1	1	0	sub A		
1	1	1	add 0	←	-A+A
		A			

A "1" in this bit means the previous stage needed to add 4*A. Since this stage is shifted by 2 bits with respect to the previous stage, adding 4*A in the previous stage is like adding A in this stage! 38

CSD Multiplier Design Canonic Signed Digit Representation

- CSD represents numbers using 1, 1, & 0 with the least possible number of non-zero digits.
 - Strings of 2 or more non-zero digits are replaced.
 - Leads to a unique representation.
- □ To form CSD representation might take 2 passes:
 - First pass: replace all occurrences of 2 or more 1's:

01..10 by 10..<u>1</u>0

 Second pass: same as above, plus replace 0110 by 0010 and 0110 by 0010

□ Examples:

011101 = 29

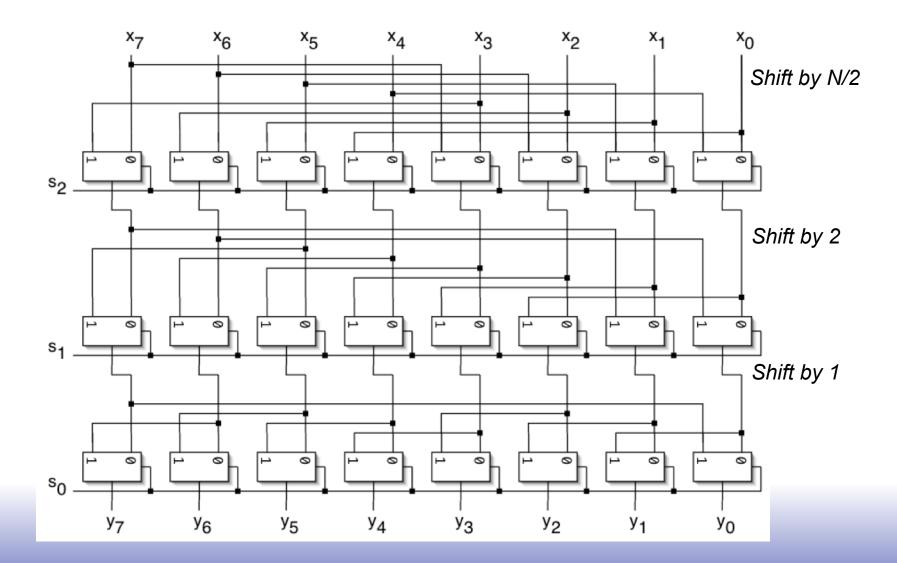
 $100\overline{1}01 = 32 - 4 + 1$

 $\begin{array}{rcl} 0010111 &=& 23 & & 0110110 &=& 54 \\ 001100\overline{1} & & & & 10\overline{1}0\overline{1}0 \\ 010\overline{1}00\overline{1} &=& 32-8-1 & & 100\overline{1}0\overline{1}0 &=& 64-8-2 \end{array}$

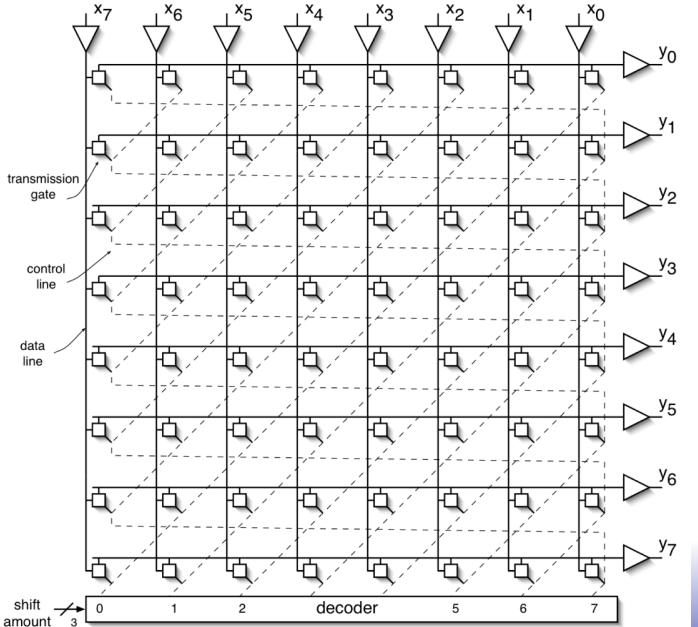
Can we further simplify the multiplier circuits?

Log and Barrel Shifters Design and Analysis Log Shifter / Rotator

□ Log(N) stages, each shifts (or not) by a power of 2 places, $S=[s_2;s_1;s_0]$:



Barrel Shifter Log and Barrel Shifters Design and Analysis



Cost/delay?

(don't forget the decoder)

Effect of Clock Uncertainties on Maximum Clock Frequency Clock Constraints in Edge-Triggered Systems

If launching edge is late and receiving edge is early, the data will not be too late if:

$$t_{clk-q,max}$$
 + $t_{logic,max}$ + t_{setup} < T_{CLK} - $t_{JS,1}$ - $t_{JS,2}$ + δ

Minimum cycle time is determined by the maximum delays through the logic

$$t_{clk-q,max} + t_{logic,max} + t_{setup} - \delta + 2t_{JS} < T_{CLK}$$

Skew can be either positive or negative
Jitter t_{JS} usually expressed as peak-to-peak or n x RMS value

Clock Constraints in Edge-Triggered Systems

If launching edge is early and receiving edge is late:

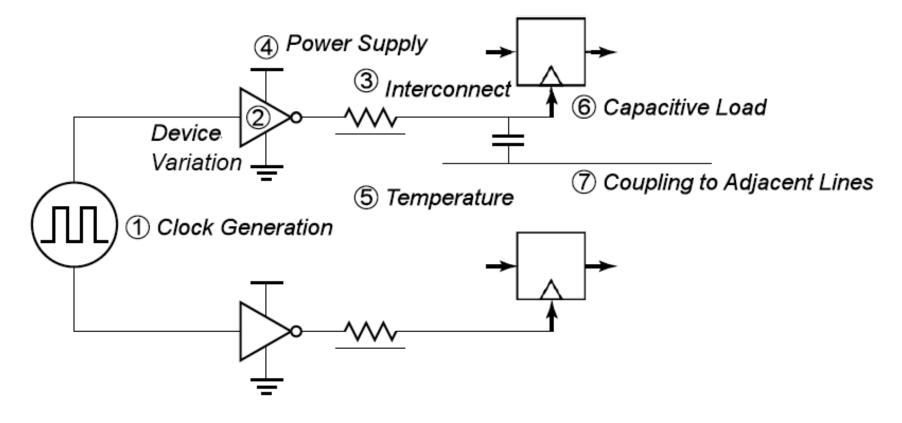
 $t_{clk-q,min} + t_{logic,min} - t_{JS,1} > t_{hold} + t_{JS,2} + \delta$

Minimum logic delay

 $t_{clk-q,min} + t_{logic,min} > t_{hold} + 2t_{JS} + \delta$ (This assumes jitter at launching and receiving clocks are independent – which usually is not true)

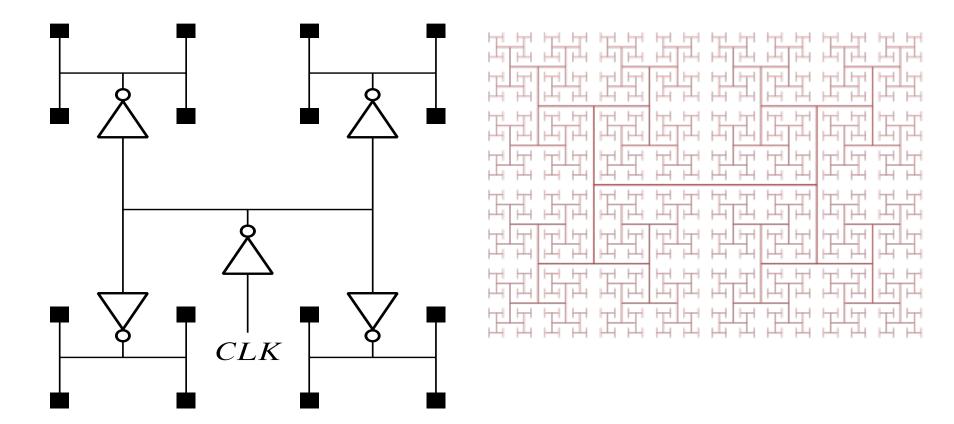
Source of Clock Uncertainties Clock Uncertainties

Sources of clock uncertainty





Principles of Good Clock Distribution

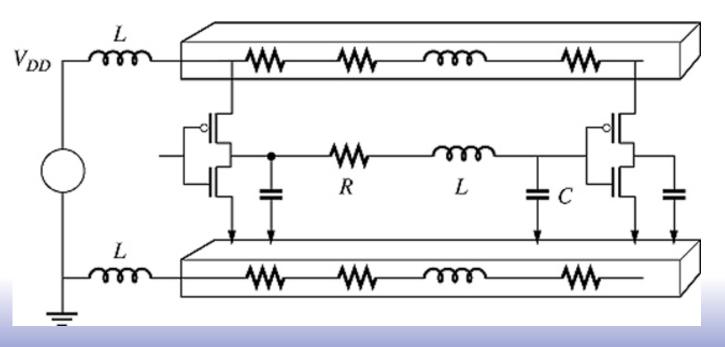


Equal wire length/number of buffers to get to every location

IR and dI/dt effects in Power distribution Power Supply Impedance

□ No voltage source is ideal - ||Z|| > 0

- □ Two principal elements increase Z:
 - Resistance of supply lines (IR drop)
 - Inductance of supply lines (L·di/dt drop)





Special thanks to our GSIs: Yukio, Rahul, Dhruv, Lux, and Daniel (reader).

Good luck on the final.

□ Thanks for a great semester!